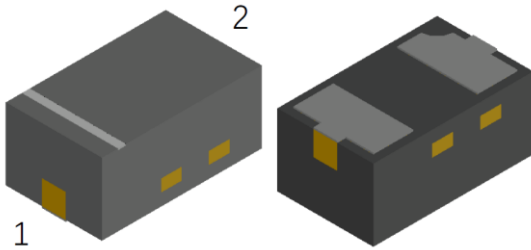


Small Signal Schottky Diode



Features

- Moisture sensitivity level 3
- Reverse voltage: 70V
- Average forward current: 70mA

Application

- High frequency and low voltage rectifier

Mechanical data

- **Package:** DFN1006-2L
- **Terminals:** Tin plated leads, solderable per J-STD-002 and JESD22-B102

■ Maximum Ratings ($T_a=25^\circ\text{C}$ Unless otherwise specified)

Parameter	Symbol	Unit	Value
Device marking code			73
Repetitive peak reverse voltage	V_{RRM}	V	70
Forward current	I_F	mA	70
Non-repetitive surge peak forward current @ $t=8.3\text{ms}$ half-sine wave	I_{FSM}	A	0.1
Non-repetitive surge peak forward current @ $t=1\text{ms}$ square wave			0.1
Repetitive Peak Forward Current @ $t_p=1\text{ms}$, $\delta=0.25$	I_{FRM}	A	0.07
Power dissipation	P_D	mW	150
Junction temperature	T_J	$^\circ\text{C}$	-55 to +125
Storage temperature	T_{STG}	$^\circ\text{C}$	-55 to +150



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■ Electrical Characteristics (T_a=25°C Unless otherwise specified)

Parameter	Symbol	Unit	Conditions	Min	Typ	Max
Reverse voltage	V _R	V	I _R =10μA	70		
Forward voltage	V _{F1}	mV	I _F =1mA			410
	V _{F2}	mV	I _F =15mA			1000
Reverse voltage leakage current	I _R	nA	V _R =50V			200
Capacitance	C _j	pF	V _R =1V, f=1MHz			2
Reverse recovery time	T _{rr}	ns	I _F =I _R =10mA, I _{rr} =0.1*I _R , R _L =100Ω			5

■ Thermal Characteristics

Parameter	Symbol	Unit	Value
Thermal resistance, junction-to-ambient	R _{θJ-A} ⁽¹⁾	°C/W	667
Thermal resistance, junction-to-case	R _{θJ-C} ⁽¹⁾	°C/W	534

Note:

(1) Thermal resistance from junction to ambient and from junction to case mounted on P.C.B. with 17mm*10mm copper pad areas



■ Characteristics

Fig 1: P_D-T_a Curve

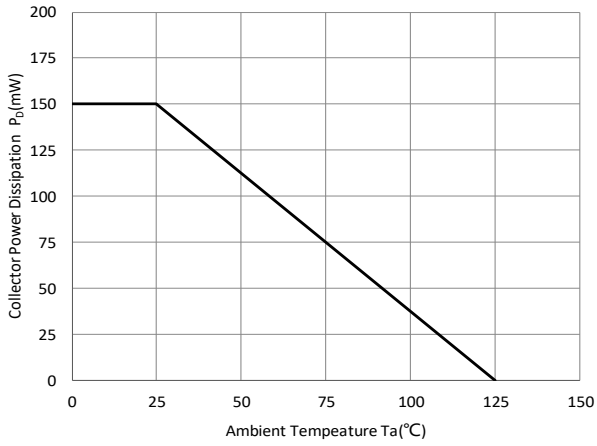


Fig 2: Capacitance Capability

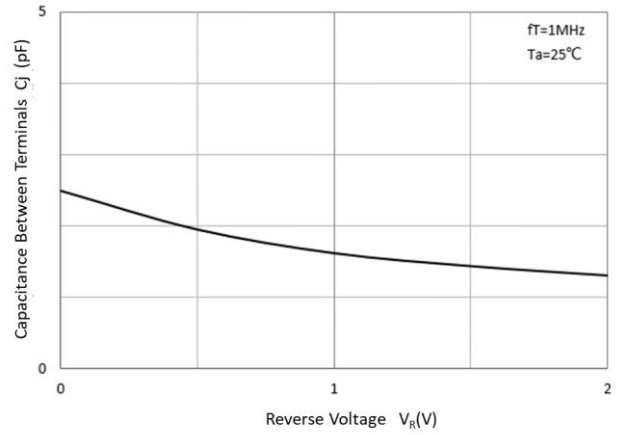


Fig 3: Typical Forward Characteristics

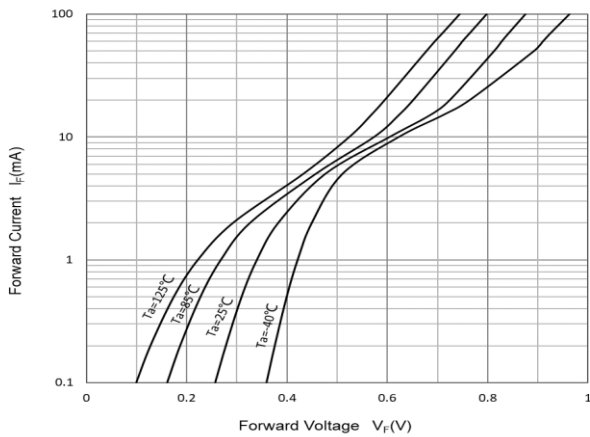
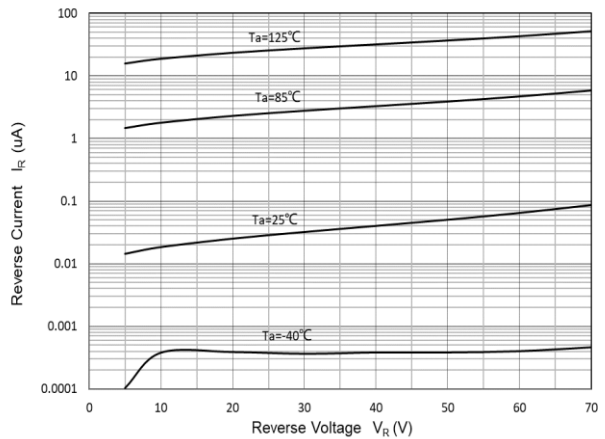


Fig 4: Typical Reverse Characteristics





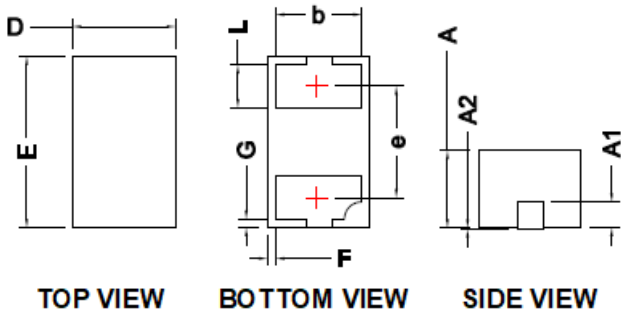
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■ Ordering Information

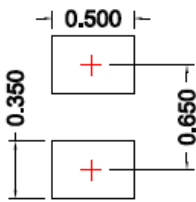
Preferred P/N	Packing code	Unit weight(g)	Minimum package(pcs)	Inner box quantity(pcs)	Outer carton quantity(pcs)	Delivery mode
BAS70L2	F1	Approximate 0.9	10000	100000	400000	Tape & Reel

■ Outline Dimensions



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
D	0.50	0.60	0.70
E	0.90	1.00	1.10
A	0.35	0.45	0.55
A1	0.15 BSC		
A2			0.10
F	0.005		
G	0.005		
L	0.15	0.25	0.35
b	0.41	0.50	0.59
e	0.65 BSC		

■ Suggested Pad Layout



UNIT: mm



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